

September 22, 2025

Nidec Advance Technology to Exhibit Products at
PCIM Asia Shanghai 2025

Nidec Advance Technology Corporation (“Nidec Advance Technology” or the “Company”) announced today that it will exhibit products at PCIM Asia Shanghai 2025, an event to be held at Shanghai New International Expo Centre from Wednesday, September 24 – Friday, September 26, 2025.



PCIM Asia Shanghai 2025, an international exhibition that represents the power electronics industry, is a platform to see cutting-edge technologies and latest trends to capture the market’s new developments. This exhibition covers the entire value chains, ranging from power semiconductors to packaging and systems to applications.

At PCIM Asia Shanghai 2025, Nidec Advance Technology will showcase its state-of-the-art, power semiconductor-related inspection technologies and equipment including IGBT/SiC, while demonstrating its NATS series products (IGBT/SiC/GaN power-module inspection equipment), and offering diverse power semiconductor inspection solutions such as multi-testers.

About PCIM Asia Shanghai 2025:

- Period: Wednesday, September 24 – Friday, September 26, 2025
- Venue: Shanghai New International Expo Centre
- Booth: B46
- Official website: pcimasia-shanghai.cn.messefrankfurt.com

Nidec Advance Technology’s main exhibit will include:

- NATS Series (IGBT/SiC semiconductor power module reliability inspection equipment)
- R-700 Series (AC/DC capacitor measurement multi-tester)